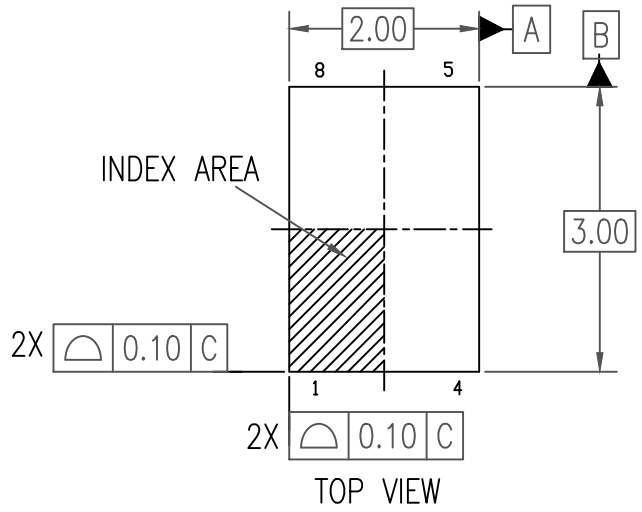
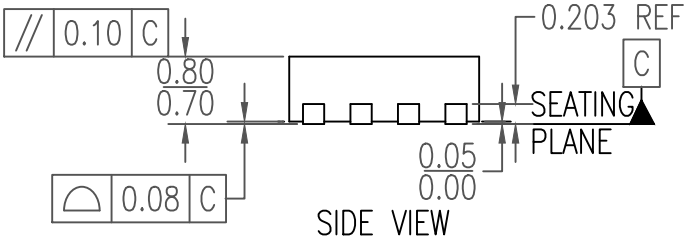
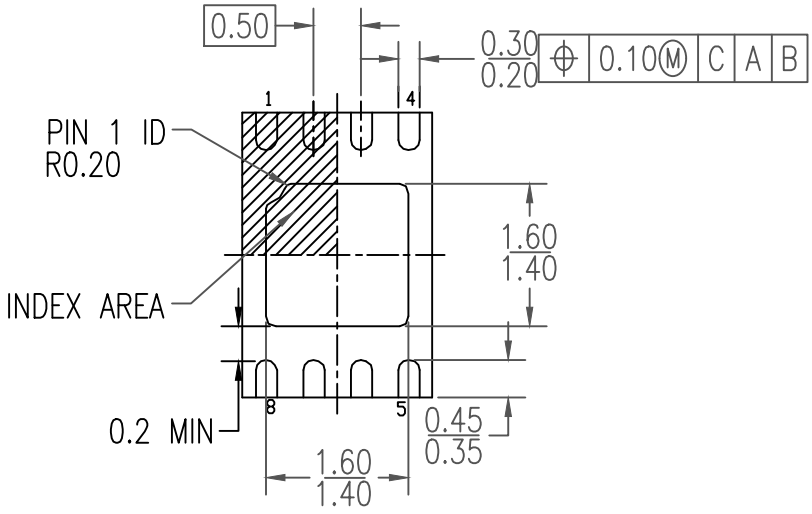


TOP VIEW



SIDE VIEW



BOTTOM VIEW

NOTE:

1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5M–1994
2. ALL DIMENSIONS ARE IN MILLIMIMETERS ANGLES ARE IN DEGREES
3. PIN 1 LOCATION IS EITHER IDENTIFIED BY NOTCH OR CHAMFER

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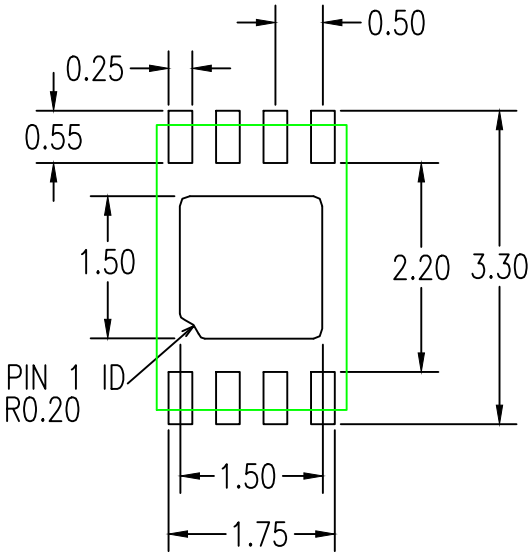

RECOMMENDED LAND PATTERN DIMENSION

NOTES:

1. ALL DIMENSIONS ARE IN MM. ANGLES IN DEGREES.
2. TOP DOWN VIEW. AS VIEWED ON PCB.
3. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.
4. COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN.

Package Revision History		
Date Created	Rev No.	Description
June 26, 2018	Rev 01	Add Component Outline for Foot Print in Green
June 4, 2021	Rev 02	Update to Renesa Logo

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